

# MOS FIELD EFFECT TRANSISTOR $\mu$ PA1706

## SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### **DESCRIPTION**

This product is N-Channel MOS Field Effect Transistor designed for DC/DC converters and power management applications of notebook computers.

#### **FEATURES**

• Super Low on-resistance

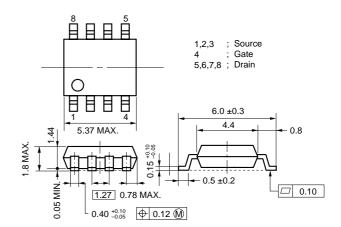
$$\begin{split} &R_{DS(on)1} = 5.8 \ m\Omega \ (TYP.) \ (V_{GS} = 10 \ V, \ I_{D} = 7.0 \ A) \\ &R_{DS(on)2} = 7.0 \ m\Omega \ (TYP.) \ (V_{GS} = 4.5 \ V, \ I_{D} = 7.0 \ A) \\ &R_{DS(on)3} = 8.0 \ m\Omega \ (TYP.) \ (V_{GS} = 4.0 \ V, \ I_{D} = 7.0 \ A) \end{split}$$

- Low Ciss : Ciss = 3000 pF (TYP.)
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

#### **ORDERING INFORMATION**

| PART NUMBER | PACKAGE    |
|-------------|------------|
| μPA1706G    | Power SOP8 |

#### **PACKAGE DRAWING (Unit: mm)**



#### **EQUIVALENT CIRCUIT**

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C, All terminals are connected)

| Drain to Source Voltage Note1                         | VDSS      | 30           | V  |
|---|-----------|--------------|----|
| Gate to Source Voltage Note2                          | Vgss      | ±20          | V  |
| Drain Current (DC)                                    | ID(DC)    | ±13          | Α  |
| Drain Current (pulse) Note3                           | ID(pulse) | ±52          | Α  |
| Total Power Dissipation (T <sub>A</sub> = 25°C) Note4 | Рт        | 2.0          | W  |
| Channel Temperature                                   | Tch       | 150          | °C |
| Storage Temperature                                   | Tstg      | -55 to + 150 | °C |

Gate Body Diode

Gate Protection Source

Notes 1. Vgs = 0 V

- **2.**  $V_{DS} = 0 V$
- **3.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %
- 4. Mounted on ceramic substrate of 1200 mm<sup>2</sup> x 0.7mm

**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

The information in this document is subject to change without notice.



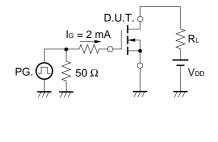
#### ELECTRICAL CHARACTERISTICS (TA = 25°C, All terminals are connected)

|                                     |                      | ,  |      |      |      |      |
|-------------------------------------|----------------------|--|------|------|------|------|
| CHARACTERISTICS                     | SYMBOL               | TEST CONDITIONS                                | MIN. | TYP. | MAX. | UNIT |
| Drain to Source On-state Resistance | RDS(on)1             | Vgs = 10 V, ID = 7.0 A                         |      | 5.8  | 7.8  | mΩ   |
|                                     | RDS(on)2             | Vgs = 4.5 V, ID = 7.0 A                        |      | 7.0  | 10.0 | mΩ   |
|                                     | RDS(on)3             | VGS = 4.0 V, ID = 7.0 A                        |      | 8.0  | 12.0 | mΩ   |
| Gate to Source Cut-off Voltage      | V <sub>GS(off)</sub> | V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA  | 1.5  | 2.0  | 2.5  | V    |
| Forward Transfer Admittance         | yfs                  | V <sub>DS</sub> = 10 V, I <sub>D</sub> = 7.0 A | 10   | 22   |      | S    |
| Drain Leakage Current               | IDSS                 | V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V  |      |      | 10   | μΑ   |
| Gate to Source Leakage Current      | lgss                 | Vgs = ±20 V, Vps = 0 V                         |      |      | ±10  | μΑ   |
| Input Capacitance                   | Ciss                 | Vps = 10 V                                     |      | 3000 |      | pF   |
| Output Capacitance                  | Coss                 | V <sub>G</sub> S = 0 V                         |      | 950  |      | pF   |
| Reverse Transfer Capacitance        | Crss                 | f = 1 MHz                                      |      | 380  |      | pF   |
| Turn-on Delay Time                  | td(on)               | ID = 7.0 A                                     |      | 40   |      | ns   |
| Rise Time                           | tr                   | V <sub>GS(on)</sub> = 10 V                     |      | 220  |      | ns   |
| Turn-off Delay Time                 | td(off)              | V <sub>DD</sub> = 15 V                         |      | 140  |      | ns   |
| Fall Time                           | t <sub>f</sub>       | $R_G = 10 \Omega$                              |      | 90   |      | ns   |
| Total Gate Charge                   | Q <sub>G</sub>       | ID = 13 A                                      |      | 56   |      | nC   |
| Gate to Source Charge               | Qgs                  | V <sub>DD</sub> = 24 V                         |      | 9    |      | nC   |
| Gate to Drain Charge                | Q <sub>GD</sub>      | V <sub>GS</sub> = 10 V                         |      | 14   |      | nC   |
| Body Diode Forward Voltage          | V <sub>F(S-D)</sub>  | IF = 13 A, Vgs = 0 V                           |      | 0.8  |      | V    |
| Reverse Recovery Time               | trr                  | IF = 13 A, VGS = 0 V                           |      | 43   |      | ns   |
| Reverse Recovery Charge             | Qrr                  | di/dt = 100 A/ μs                              |      | 50   |      | nC   |

#### **TEST CIRCUIT 1 SWITCHING TIME**

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#### **TEST CIRCUIT 2 GATE CHARGE**

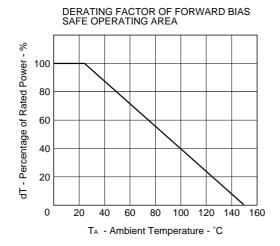


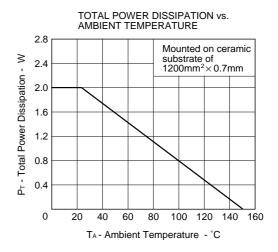
 $\mathsf{V}_{\mathsf{GS}}$ 

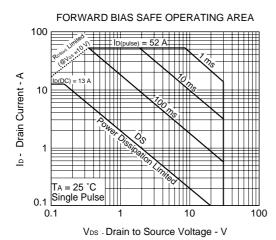
 $\tau = 1 \mu \text{ s}$ Duty Cycle  $\leq 1 \%$ 



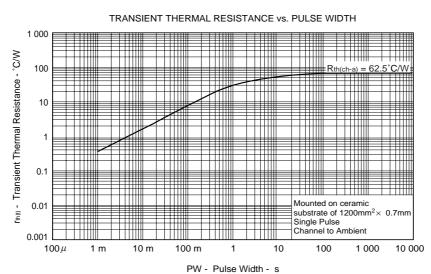
#### TYPICAL CHARACTERISTICS (TA = 25 °C)



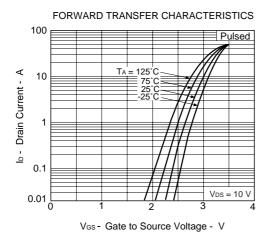


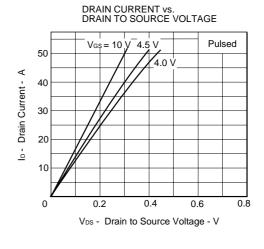


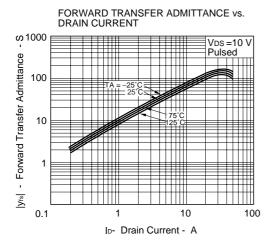
**Remark** Mounted on ceramic substrate of  $1200 \text{mm}^2 \times 0.7 \text{mm}$ 

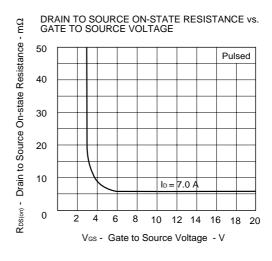


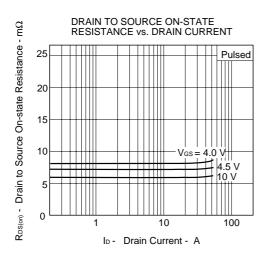
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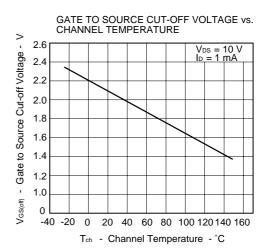




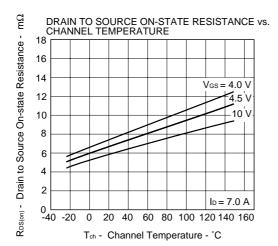


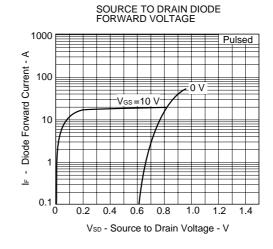


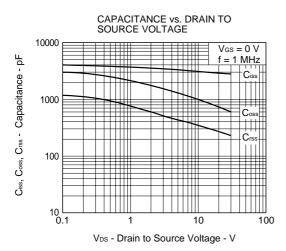


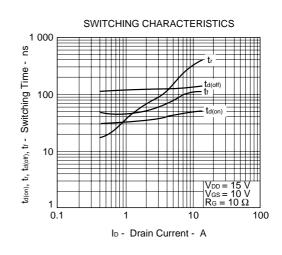


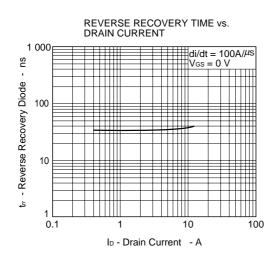


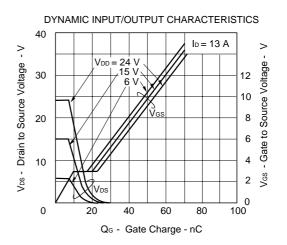












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Anti-radioactive design is not implemented in this product.

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